

12-13-2005

ET

11/30/05



103135293

To the Director of the U.S. Patent and

documents or the new address(es) below.

1. Name of conveying party(ies)

Richard A. Hoffman (1), Murray J. Bordeaux (2), William R. Sessoms (3), Rodney L. Thompson (2), Stephen D. Horton (2)

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance/Execution Date(s):

Execution Date(s) (1) 11/07/05, (2) 11/08/05, (3) 11/09/05

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Joint Research Agreement
☐ Government Interest Assignment
☐ Executive Order 9424, Confirmatory License
☐ Other

2. Name and address of receiving party(ies)

Name: Dymetrol Company, Inc.

Internal Address: _____

Street Address: 724 Yorklyn Road, Suite 280

City: Hockessin

State: DE

Country: USA Zip: 19707

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application or patent number(s):

☒ This document is being filed together with a new application.

A. Patent Application No.(s)

B. Patent No.(s)

12/05/2005 SHASSEN1 00000011 11290743

04 FC:3021

40.00 DP

Additional numbers attached? ☐ Yes ☒ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Brian A. Gomez

Internal Address: _____

Street Address: 1501 N. Rodney Street, Suite 101

City: Wilmington

State: DE Zip: 19806

Phone Number: (302) 351-3323

Fax Number: (302) 351-8456

Email Address: bgomez@gomez-ipo.com

6. Total number of applications and patents involved: One (1)

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

- ☒ Authorized to be charged by credit card
☐ Authorized to be charged to deposit account
☐ Enclosed
☐ None required (government interest not affecting title)

8. Payment Information

a. Credit Card Last 4 Numbers 9453
Expiration Date May 2008

b. Deposit Account Number _____

Authorized User Name _____

9. Signature:

Brian A. Gomez
Signature

30 November 2005
Date

Brian A. Gomez

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents: 2

Documents to be recorded (including cover sheet) should be faxed to (703) 306-5995, or mailed to:
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O.Box 1450, Alexandria, V.A. 22313-1450

PATENT
REEL: 017326 FRAME: 0880

ASSIGNMENT

We, the undersigned, Richard A. HOFFMAN, Murray J. BORDEAUX, William R. SESSOMS, Rodney L. THOMPSON and Stephen D. HORTON

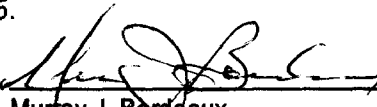
Hereby declare that

We are the true and first inventors of an invention relating to **Bundling System With Improved Locking Tie Head**, which is disclosed in an application for Letters Patent in the United States of America, and submitted herewith, (Attorney Docket No.: Dymetrol-3 USA); and, for valuable consideration, the receipt and adequacy of which is hereby acknowledged and in fulfillment of my pre-existing obligation of assignment, WE hereby sell, assign, and transfer unto **DYMETROL COMPANY, INC.**, a corporation organized and existing under the laws of Delaware and having its principal place of business at **724 Yorklyn Road, Suite 280, Hockessin, DE 19707**, hereinafter referred to as the Assignee, the entire right, title, and interest in and to the aforesaid application for Letters Patent, including any priority rights derived from the aforesaid application for Letters Patent by virtue of the International Convention for the Protection of Industrial Property for any and all member countries of the aforesaid International Convention, and the entire right, title and interest in and to any and all of my inventions, whether joint or sole, disclosed in the aforesaid application for Letters Patent, and in and to any and all applications for Letters Patent for any such inventions in any country whatsoever, and in and to any and all patents for any such inventions in any country whatsoever, with the sole right to file such applications in its name or mine, including the sole right to file such applications under the aforesaid International Convention, together with the sole right to have said patents granted in its name or mine and to enforce said patents and to sue for and recover profits and damages for any and all infringements thereof, and hereby agree, whenever requested, to communicate to said Assignee, its successors, assigns, and legal representatives, any facts known to me respecting said inventions, to testify in any legal proceeding, to execute all applications, papers or instruments necessary or required by said Assignee, its successors, assigns and legal representatives to carry into effect any of the provisions of this instrument, and generally to do everything possible to aid said Assignee, its successors, assigns, and legal representatives to obtain and enforce proper patent protection for said inventions in any and all countries.

Signed and sealed this 7 day of Nov, 2005.


Richard A. Hoffman (L.S.)

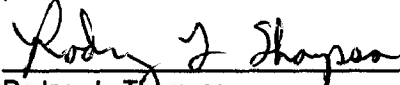
Signed and sealed this 8 day of Nov, 2005.


Murray J. Bordeaux (L.S.)

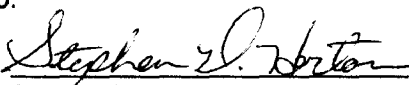
Signed and sealed this 9 day of Nov 2005.


William R. Sessoms (L.S.)

Signed and sealed this 8 day of Nov, 2005.


Rodney L. Thompson (L.S.)

Signed and sealed this 8 day of Nov 2005.


Stephen D. Horton (L.S.)